



## Customer Information Notification

202607019I : S32K144 LQFP100 Final Test Site Expansion from NXP-ATTJ to NXP-ATKL

**Note:** This notice is NXP Company  
Proprietary.

**Issue Date:** Aug 05, 2026 **Effective Date:** Sep 05, 2026

Dear Emma Tempest,

Here is your personalized communication about an NXP notification.  
For detailed information we invite you to [view this notification online](#)

### Change Category

|                                   |                                                    |                                          |                                     |
|-----------------------------------|----------------------------------------------------|------------------------------------------|-------------------------------------|
| <input type="checkbox"/> Wafer    | <input type="checkbox"/>                           | <input type="checkbox"/> Test            | <input type="checkbox"/>            |
| Fab                               | <input type="checkbox"/> Assembly                  | Process                                  | <input type="checkbox"/> Design     |
| Process                           | <input type="checkbox"/> Product Marking           |                                          |                                     |
|                                   | Process                                            |                                          |                                     |
| <input type="checkbox"/> Wafer    | <input type="checkbox"/>                           | <input type="checkbox"/> Test            | <input type="checkbox"/>            |
| Fab                               | <input type="checkbox"/> Assembly                  | Equipment                                | <input type="checkbox"/> Errata     |
| Materials                         | <input type="checkbox"/> Mechanical Specification  |                                          |                                     |
|                                   | Materials                                          |                                          |                                     |
| <input type="checkbox"/> Wafer    | <input type="checkbox"/>                           | <input checked="" type="checkbox"/> Test | <input type="checkbox"/>            |
| Fab                               | <input type="checkbox"/> Assembly                  | Location                                 | <input type="checkbox"/> Electrical |
| Location                          | <input type="checkbox"/> Packing/Shipping/Labeling |                                          | spec./Test                          |
|                                   | Location                                           |                                          | coverage                            |
| <input type="checkbox"/>          | <input type="checkbox"/>                           |                                          |                                     |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other                     |                                          |                                     |

### Notification Overview

## Description

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NXP Semiconductors announces the Final Test site expansion for the S32K144 LQFP00, Mask set 0N57U, devices associated with this notification, from the current NXP-ATTJ-B2, Tianjin, China to NXP-ATKL, Kuala Lumpur, Malaysia Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01

Please see the attached file(s) for additional details.

## Reason

Qualification of NXP-ATKL, Kuala Lumpur, Malaysia Final Test site is required for manufacturing flexibility and customer supply assurance.

## Identification of Affected Products

Product identification does not change

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

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No Impact on form, fit, function, reliability or quality

## Additional information

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Additional documents: [view online](#)

## Contact and Support

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For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

|                       |                                                                    |
|-----------------------|--------------------------------------------------------------------|
| <b>Name</b>           | Amanda Shearer                                                     |
| <b>Position</b>       | Change Management                                                  |
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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

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